



Attorney's Docket No.: 07977/017002/US2968C1D1

2813  
SS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Yamazaki, et al. Art Unit : 2813  
Serial No.: 09/451,665 Examiner : Laura Schillinger  
Filed : November 30, 1999  
Title : SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD  
THEREOF

Commissioner for Patents  
Washington, D.C. 20231

TRANSMITTAL LETTER

Correspondence relating to this application is enclosed.  
The required fees are computed below. Please apply any charges  
not covered, or any credits, to Deposit Account No. 06-1050.

Total Claims	82	-	56	=	26	\$468
Independent	10	-	8	=	2	\$160
TOTAL FEE DUE						\$628

A check for \$628 is attached.

Respectfully submitted,

Date: 8/8/01

Scott C. Harris  
Reg. No. 32,030

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CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, Washington, D.C. 20231.

August 8, 2001

Date of Deposit

Signature

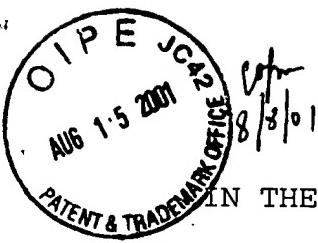
Susan Regan

Typed or Printed Name of Person Signing Certificate

TECHNOLOGY CENTER 2800

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AMENDMENT

Sir:

In response to the Official Action dated May 9, 2001, Paper No. 8, in the above-referenced application, please amend the above-identified application as follows.

In the Claims:

Please amend the claims as follows.

*Sub D1* 1. (Amended) A method of manufacturing a semiconductor device comprising the steps of:  
*C1* forming a crystalline semiconductor film on an insulating surface;

03/17/2001 MWOLDER1 00000071 09451665

01 FC:102  
02 FC:103

160.00 OP  
468.00 OP

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August 8, 2001

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*Susan Regan*

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Susan Regan

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